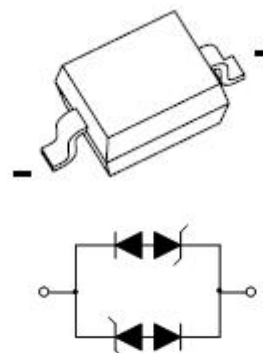


**SOD-323 Plastic-Encapsulate Diodes****ESDBKV5V0D3 Bi-direction ESD Protection Diode****DESCRIPTION**

Designed to protect voltage sensitive electronic components from ESD and other transients. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

The combination of small size, low capacitance, and high level of ESD protection makes them a flexible solution for applications such as HDMI, Display Port TM, and MDDI interfaces. It is designed to replace multiplayer varistors (MLV) in consumer equipments applications such as mobile phone, notebook, PAD, STB, LCD TV etc.

SOD-323**FEATURES**

- Bi-directional ESD protection of one line
- Low capacitance: 2pF
- Low reverse stand-off voltage: 5V
- Low reverse clamping voltage
- Low leakage current
- Excellent package: 1.7mm × 1.3mm × 1.0mm
- Fast response time
- JESD22-A114-B ESD Rating of class 3B per human body model
- IEC 61000-4-2 Level 4 ESD protection

APPLICATIONS

- Cellular phones
- High speed data lines
- Handheld-Wireless Systems
- PDAs
- Ethernet – 10/100/1000 Base T
- Portable electronics
- USB Interface
- Other electronics equipments communication systems

MARKING

Front side

BV5 = Device code

Solid dot = Green molding compound device.

MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
IEC 61000-4-2 ESD Voltage	$V_{\text{ESD}}^{(1)}$	± 25	kV
Air Model			
Contact Model		± 25	
JESD22-A114-B ESD Voltage		± 16	
ESD Voltage	Machine Model	± 0.4	
Peak Pulse Power	$P_{\text{PP}}^{(2)}$	460	W
Peak Pulse Current	$I_{\text{PP}}^{(2)}$	23	A
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	$^{\circ}\text{C}$
Storage Temperature Range	T_J, T_{stg}	$-55 \sim +150$	$^{\circ}\text{C}$
Power Dissipation	$P_D^{(3)}$	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta\text{JA}}^{(3)}$	625	$^{\circ}\text{C/W}$
Thermal Resistance from Junction to Case	$R_{\theta\text{JC}}^{(4)}$	125	$^{\circ}\text{C/W}$

(1).Device stressed with ten non-repetitive ESD pulses.

(2).Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.

(3).Device mounted on 1 in² FR-4 board with 2oz. single-sided Copper, in a still air environment with $T_A=25^{\circ}\text{C}$.

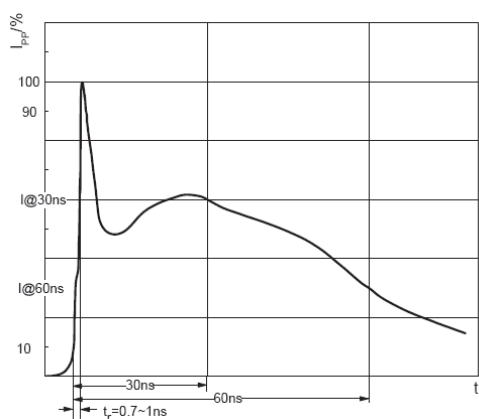
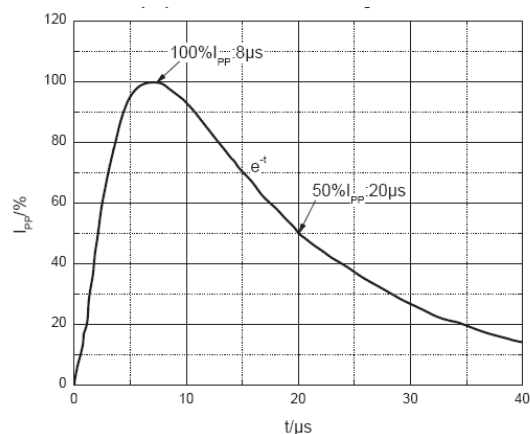
(4). $T_C=25^{\circ}\text{C}$ Limited only by maximum temperature allowed.

ESD standards compliance**IEC61000-4-2 Standard**

Contact Discharge		Air Discharge	
Level	Test Voltage kV	Level	Test Voltage kV
1	2	1	2
2	4	2	4
3	6	3	8
4	8	4	15

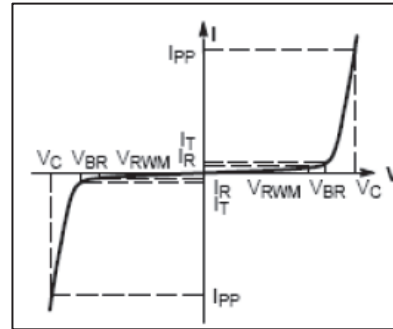
JESD22-A114-B Standard

ESD Class	Human Body Discharge V
0	0~249
1A	250~499
1B	500~999
1C	1000~1999
2	2000~3999
3A	4000~7999
3B	8000~15999

**ESD pulse waveform according to IEC61000-4-2****8/20 μs pulse waveform according to IEC 61000-4-5**

ELECTRICAL PARAMETER

Symbol	Parameter
V_C	Clamping Voltage @ I_{PP}
I_{PP}	Peak Pulse Current
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_R	Reverse Leakage Current @ V_{RWM}
V_{RWM}	Reverse Standoff Voltage

**V-I characteristics for a Bi-directional TVS****ELECTRICAL CHARACTERISTICS($T_a=25^{\circ}\text{C}$ unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Reverse stand off voltage	$V_{RWM}^{(1)}$				5	V
Reverse leakage current	I_R	$V_{RWM}=5V$			1	μA
Breakdown voltage	$V_{(BR)}$	$I_T=1mA$	6	7.3	8	V
Clamping voltage	$V_C^{(2)}$	$I_{PP}=23A$		20		V
TLP clamping voltage	V_C	$I_{TLP}=\pm 8A$, Pulse Width=100ns		± 10.8		V
		$I_{TLP}=\pm 16A$, Pulse Width=100ns		± 13.2		V
Dynamic resistance	$R_{DYN}^{(3)}$	Pulse Width=100ns		0.30		Ω
Junction capacitance	C_J	$V_R=0V, f=1MHz$			2	pF

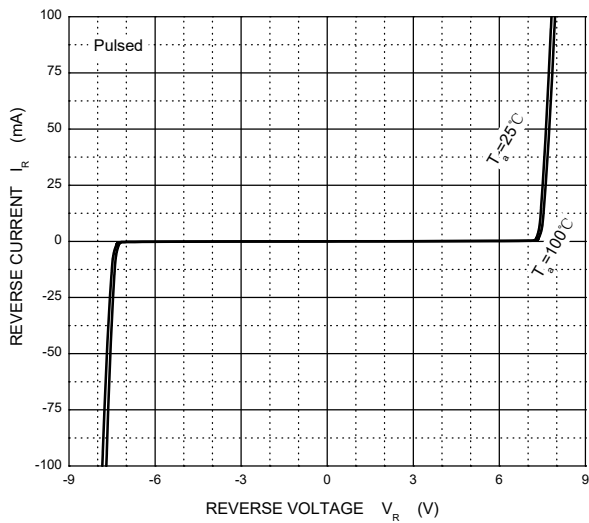
(1).Other voltages available upon request.

(2).Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.

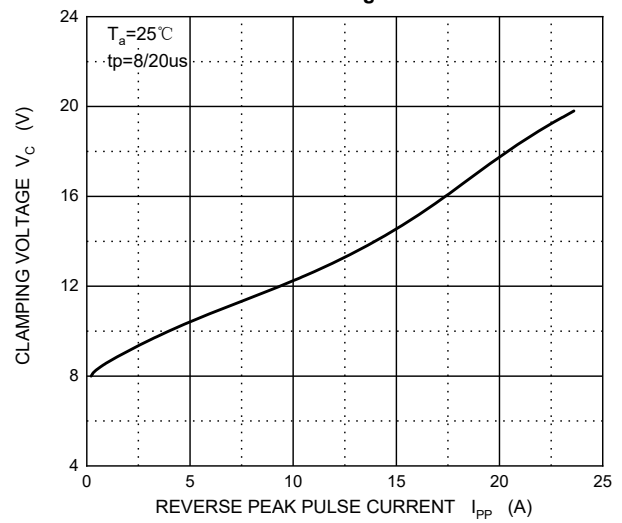
(3). R_{DYN} is calculated from 8A to 16A.

TYPICAL CHARACTERISTICS

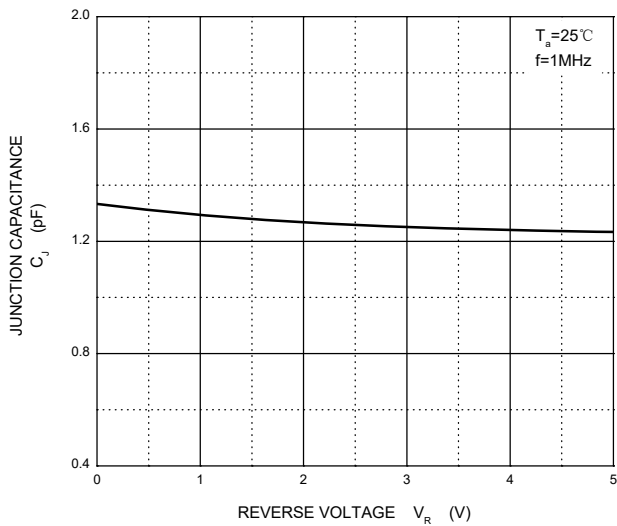
Reverse Characteristics



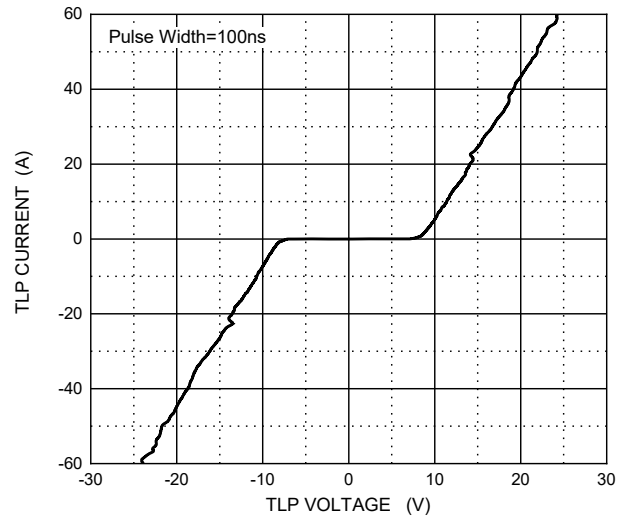
Power Derating Curve



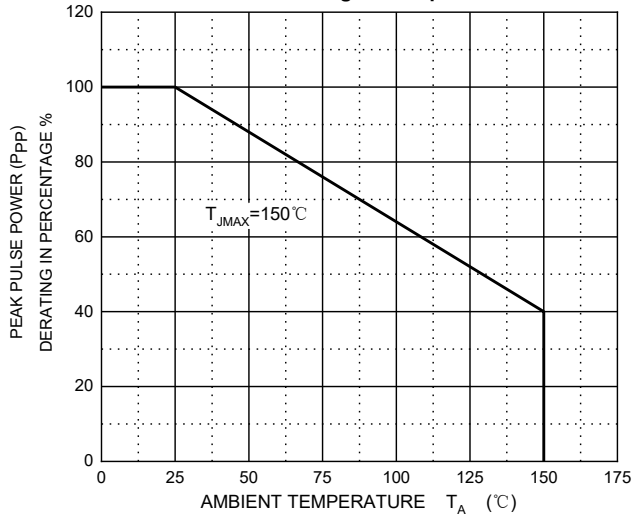
Capacitance Characteristics



Transmission Line Pulsing (TLP) Measurement

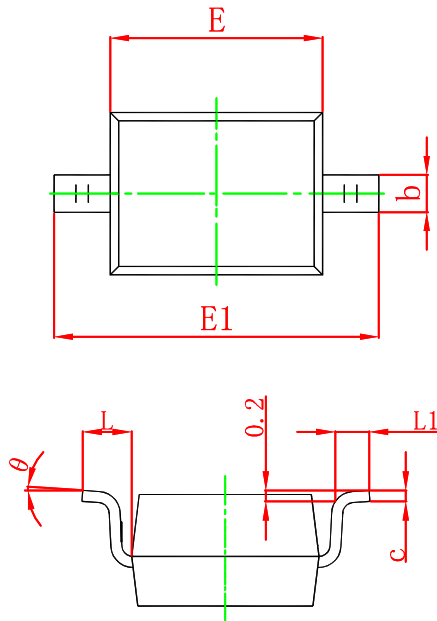


Power Derating vs. Temperature



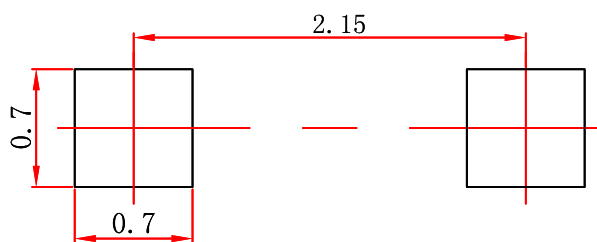
PACKAGE OUTLINE AND PAD LAYOUT INFORMATION

SOD-323 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Min	Max
	Min	Max		
A		1.100		0.043
A1	0.000	0.100	0.000	0.004
A2	0.800	1.000	0.031	0.039
b	0.250	0.350	0.010	0.014
c	0.080	0.150	0.003	0.006
D	1.200	1.400	0.047	0.055
E	1.600	1.800	0.063	0.071
E1	2.500	2.750	0.098	0.108
L	0.475 REF		0.019 REF	
L1	0.250	0.400	0.010	0.016
θ	0°	8°	0°	8°

SOD-323 Suggested Pad Layout

**Note:**

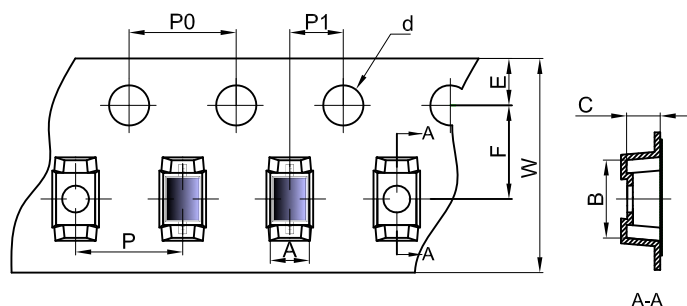
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

TAPE AND REEL INFORMATION

SOD-323 Embossed Carrier Tape

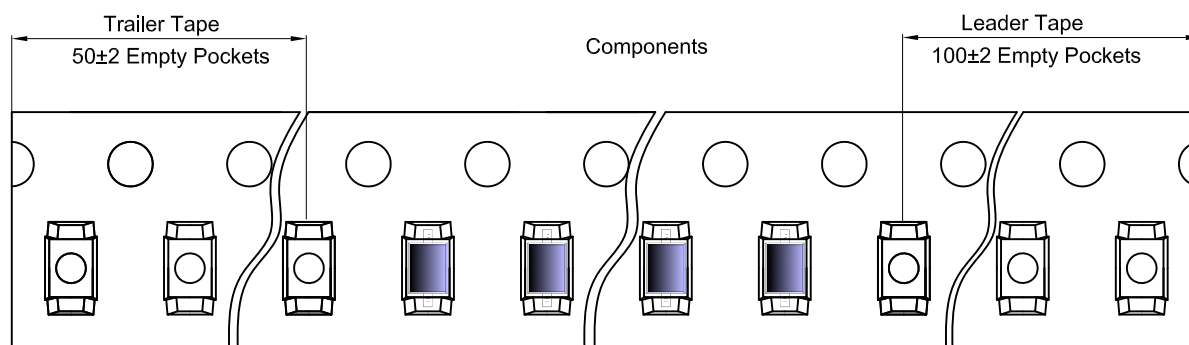


Packaging Description:

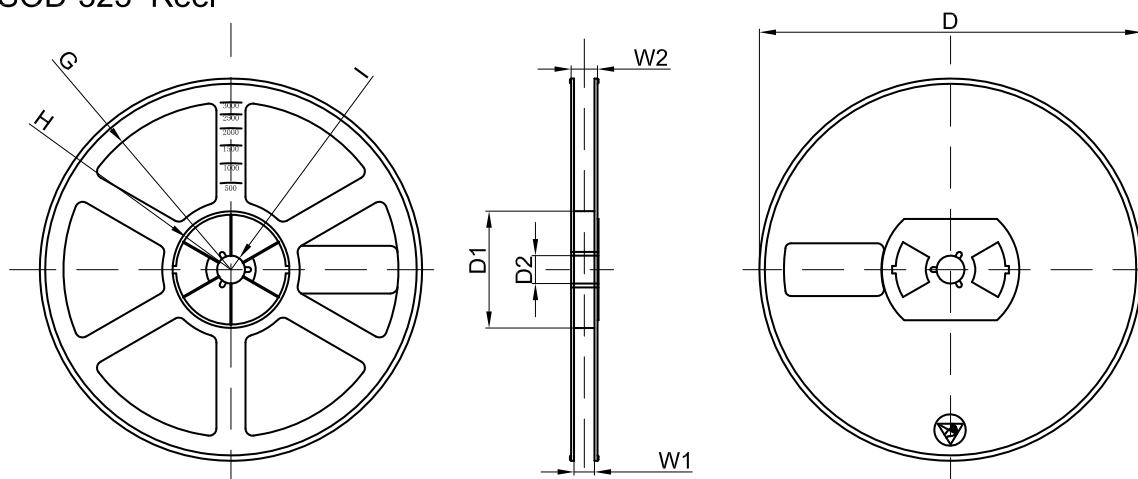
SOD-323 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOD-323	1.48	3.3	1.25	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

SOD-323 Tape Leader and Trailer



SOD-323 Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
7"Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	45,000 pcs	203×203×195	180,000 pcs	438×438×220	